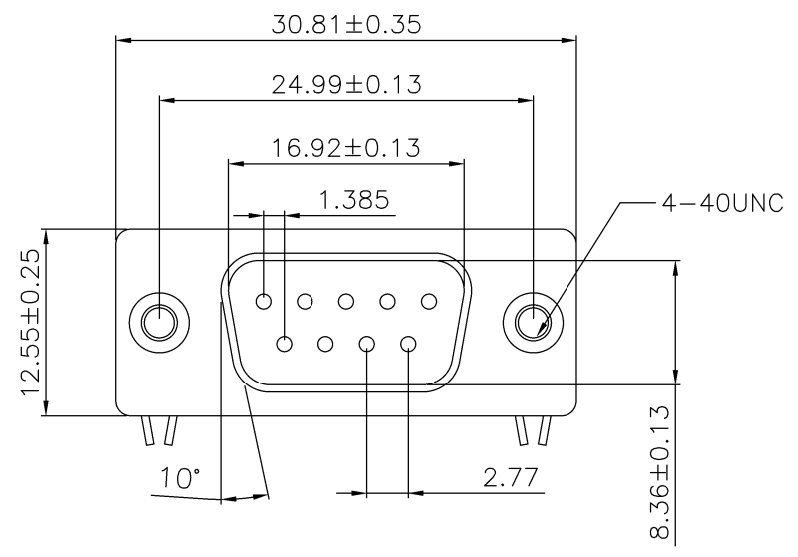
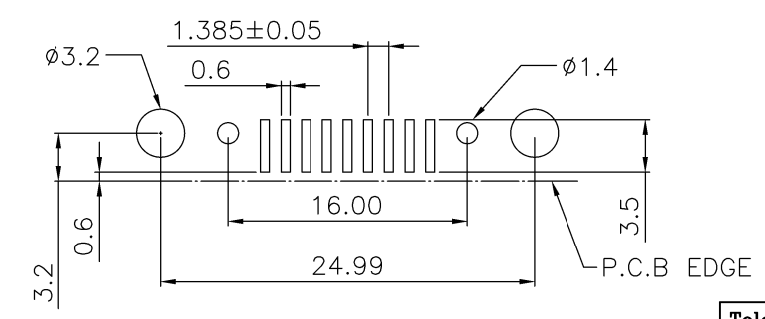
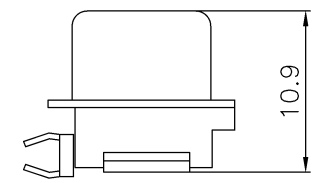
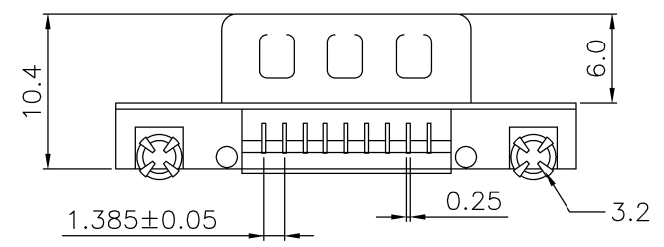


REV.	SPECIFICATION	ECN NO.	APPD.


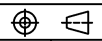


**Material:**  
Housing: LCP,UL94V-0.  
Contacts: Brass,Gold Plated on Contact Area and 80u" Min Tin Plated on solder tail over Nickel 30u" Min.  
Shell: Steel.  
**Electrical Characteristics:**  
Current Rating: 1 AMP.  
Insulation Resistance: 1000MΩ min.  
Contact Resistance: 20mΩ max.  
Operating Temperature: -30°C~+105°C.  
Max Processing Temperature: 230°C for 30~60°C Seconds.  
**\*RoHS Compliant**



7902-A 09 M C 00 D A  
Series ——— A: Tray Package  
Position ——— D: Right Angle SMD Type  
M: Male ——— 00: Gold Flash  
C: Selective Gold Plated

P.C.Board Layout

<b>Tolerances</b>	<b>Dwg No.</b>	7902D01008	<b>Title:</b>	 <b>OUPIN ELECTRONIC(KUNSHAN) CO., LTD.</b> P/N: 7902-A09MC00DA SHEET 1/1 Ver.No. A7
x = ±0.50	<b>Projection</b>		7902 Series	
.x = ±0.25	<b>Unit</b>	mm	D-SUB Connector	
.xx = ±0.15	<b>Scale</b>	1:1	Right Angle SMD Type	
	<b>Drawn By</b>	Martin 09/22'22	Ø 512	